

REASONS FOR ALLOWANCE

The following is an examiner's statement of reasons for allowance: prior art could not be located that taught a fan out wafer level package structure comprising a first dielectric layer formed on said base and filled in a space except said die on said base, wherein the first dielectric layer includes silicone rubber, epoxy, resin or BCB to act as a buffer layer to release stress; a second dielectric layer formed on said first dielectric layer and said die, wherein said second dielectric layer including a plurality of openings for contact with said plurality of pads; a contact conductive layer formed on said plurality of pads of said die and within said openings to electrically couple with said pads, respectively; a plurality of conductive lines formed on said second dielectric layer and in contact with, said contact conductive layer and substantially filling said openings, and said conductive lines being extended out from corresponding said contact conductive layer to corresponding end points. This limitation, in conjunction with the other claim limitations, was neither disclosed in, nor suggested by, the prior art.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication or earlier communications from the examiner should be directed to David A. Zarneke whose telephone number is (571)-272-1937. The examiner can normally be reached on M-Th 7:30 AM-6 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, William Baumeister can be reached on (571)-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/David A. Zarneke/
Primary Examiner, Art Unit 2891
7/21/08